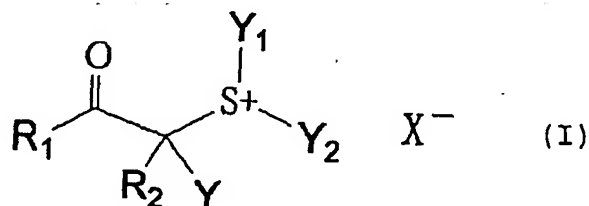


AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. (currently amended): A photosensitive composition comprising a compound capable of generating an acid upon irradiation with an actinic ray, the compound being represented by the following general formula (I):



wherein R₁ represents a substituted or an unsubstituted alkyl group provided that when R₁ represents a substituted alkyl group, the substituent is not an aryl group;

R₂ represents an alkyl group;

Y represents an alkyl group;

Y₁ and Y₂ may be the same or different and each represents an alkyl group, an aryl group, an aralkyl group, or a hetero atom-containing aromatic group;

R_1 and R_2 may be bonded to each other to form a ring;

R_2 and Y may be bonded to each other to form a ring;

Y_1 and Y_2 may be bonded to each other to form a ring;

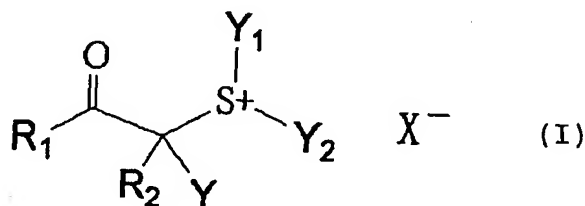
two or more structures of the general formula (I) may be bonded to each other at any position of R_1 , R_2 or Y, or Y_1 or Y_2 via a connecting group; and

X^- represents a non-nucleophilic anion.

2. (currently amended): A positive photosensitive composition comprising:

(A) a compound capable of generating an acid upon irradiation with an actinic ray, the compound being represented by the following general formula (I); and

(B) a resin that is decomposed by the action of an acid to increase its solubility in an alkaline developer:



wherein R_1 represents ~~substituted or an~~ unsubstituted alkyl group ~~provided that when R_1 represents a substituted alkyl group, the substituent is not an aryl group;~~

R_2 represents an alkyl group;

Y represents an alkyl group;

Y_1 and Y_2 may be the same or different and each represents an alkyl group, an aryl group, an aralkyl group, or a hetero atom-containing aromatic group;

R_1 and R_2 may be bonded to each other to form a ring;

R_2 and Y may be bonded to each other to form a ring;

Y₁ and Y₂ may be bonded to each other to form a ring;

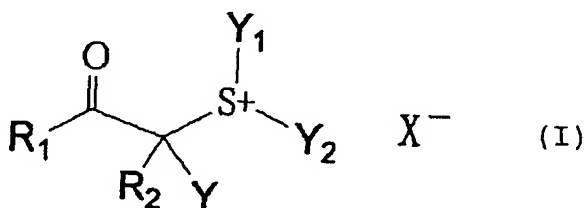
two or more structures of the general formula (I) may be bonded to each other at any position of R₁, R₂ or Y, or Y₁ or Y₂ via a connecting group; and

X- represents a non-nucleophilic anion.

3. (currently amended): ~~The positive photosensitive composition as described in claim 2~~

A positive photosensitive composition comprising:

(A) a compound capable of generating an acid upon irradiation with an actinic ray, the compound being represented by the following general formula (I):



wherein R₁ represents a substituted or unsubstituted alkyl group provided that when R₁
represents a substituted alkyl group, the substituent is not an aryl group;

R₂ represents an alkyl group;

Y represents an alkyl group;

Y₁ and Y₂ may be the same or different and each represents an alkyl group, an aryl group, an aralkyl group, or a hetero atom-containing aromatic group;

R₁ and R₂ may be bonded to each other to form a ring;

R₂ and Y may be bonded to each other to form a ring;

Y₁ and Y₂ may be bonded to each other to form a ring;

any position of R₁, R₂ or Y, or Y₁ or Y₂ via a connecting group; and

X^- represents a non-nucleophilic anion,

and

an alkaline developer, wherein the resin (B) contains a hydroxystyrene structural unit.

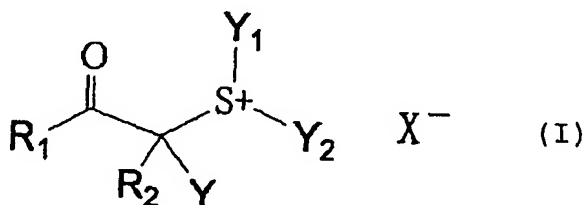
4. (original): The positive photosensitive composition as described in claim 2, wherein the resin (B) contains a monocyclic or polycyclic alicyclic hydrocarbon structure.

5. (original): The positive photosensitive composition as described in claim 4, wherein the resin (B) further contains a repeating unit having a lactone structure.

6. (currently amended): ~~The positive photosensitive composition as described in claim 2~~

A positive photosensitive composition comprising:

ray, the compound being represented by the following general formula (I):



wherein R₁ represents a substituted or unsubstituted alkyl group provided that when R₁ represents a substituted alkyl group, the substituent is not an aryl group;

_____ R₂ represents an alkyl group;

_____ Y represents an alkyl group;

_____ Y₁ and Y₂ may be the same or different and each represents an alkyl group, an aryl group, an aralkyl group, or a hetero atom-containing aromatic group;

_____ R₁ and R₂ may be bonded to each other to form a ring;

_____ R₂ and Y may be bonded to each other to form a ring;

_____ Y₁ and Y₂ may be bonded to each other to form a ring;

_____ two or more structures of the general formula (I) may be bonded to each other at any position of R₁, R₂ or Y, or Y₁ or Y₂ via a connecting group; and

_____ X⁻ represents a non-nucleophilic anion,

and

_____ (B) a resin that is decomposed by the action of an acid to increase its solubility in an alkaline developer, wherein the resin (B) contains a fluorine atom.

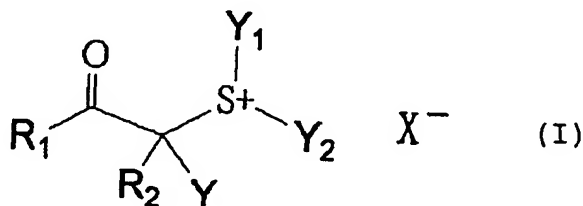
7. (original): The positive photosensitive composition as described in claim 2, which further comprises (C) a dissolution inhibiting compound having a molecular weight of not more than 3,000, which is decomposed by the action of an acid to increase its solubility in an alkaline developer.

8. (currently amended): A positive photosensitive composition comprising:

(A) a compound capable of generating an acid upon irradiation with an actinic ray, the compound being represented by the following general formula (I);

(D) an alkaline developer-soluble resin; and

(C) a dissolution inhibiting compound having a molecular weight of not more than 3,000, which is decomposed by the action of an acid to increase its solubility in an alkaline developer:



wherein R₁ represents ~~a substituted or an~~ unsubstituted alkyl group ~~provided that when R₁ represents a substituted alkyl group, the substituent is not an aryl group;~~

R₂ represents an alkyl group;

Y represents an alkyl group;

Y₁ and Y₂ may be the same or different and each represents an alkyl group, an aryl group, an aralkyl group, or a hetero atom-containing aromatic group;

R₁ and R₂ may be bonded to each other to form a ring;

R₂ and Y may be bonded to each other to form a ring;

Y₁ and Y₂ may be bonded to each other to form a ring;

two or more structures of the general formula (I) may be bonded to each other at any position of R₁, R₂ or Y, or Y₁ or Y₂ via a connecting group; and

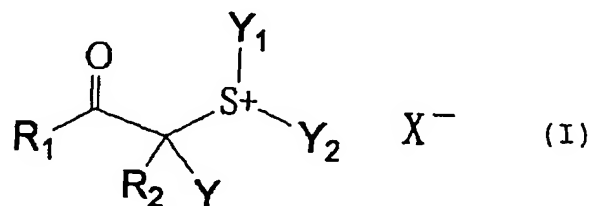
X^- represents a non-nucleophilic anion.

9. (original): A negative photosensitive composition comprising:

(A) a compound capable of generating an acid upon irradiation with an actinic ray, the compound being represented by the following general formula (I);

(D) an alkaline developer-soluble resin; and

(E) an acid crosslinking agent capable of crosslinking with the alkaline developer-soluble resin by the action of an acid:



wherein R₁ represents an alkyl group;

R₂ represents a hydrogen atom, an alkyl group, or an aryl group;

Y represents an alkyl group;

Y₁ and Y₂ may be the same or different and each represents an alkyl group, an aryl group, an aralkyl group, or a hetero atom-containing aromatic group;

R_1 and R_2 may be bonded to each other to form a ring;

R₂ and Y may be bonded to each other to form a ring;

Y_1 and Y_2 may be bonded to each other to form a ring;

two or more structures of the general formula (I) may be bonded to each other at any position of R_1 , R_2 or Y , or Y_1 or Y_2 via a connecting group; and

X^- represents a non-nucleophilic anion.

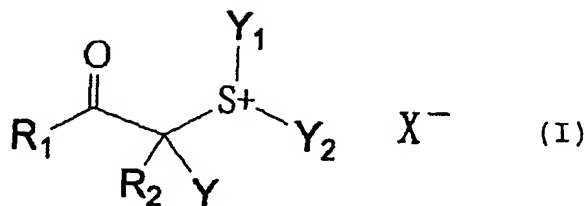
10. (original): The photosensitive composition as described in claim 1, which further comprises (F) a basic compound.

11. (original): The photosensitive composition as described in claim 1, which further comprises (G) a surfactant containing at least one of a fluorine atom and a silicon atom.

12. (original): The photosensitive composition as described in claim 1, wherein each of the R_2 and Y in the formula (I) represents an alkyl group having 1 to 20 carbon atoms.

13. (original): The photosensitive composition as described in claim 1, which further comprises at least one of an arylsulfonium compound and a compound having a phenacylsulfonium salt structure.

14. (currently amended): An acid generator represented by the following general formula (I):



wherein R_1 represents ~~a substituted or an~~ unsubstituted alkyl group ~~provided that when~~
 R_1 represents a substituted alkyl group, the substituent is not an aryl group;

R_2 represents an alkyl group;

Y represents an alkyl group;

Y_1 and Y_2 may be the same or different and each represents an alkyl group, an aryl group, an aralkyl group, or a hetero atom-containing aromatic group;

R_1 and R_2 may be bonded to each other to form a ring;

R_2 and Y may be bonded to each other to form a ring;

Y_1 and Y_2 may be bonded to each other to form a ring;

two or more structures of the general formula (I) may be bonded to each other at any position of R_1 , R_2 or Y, or Y_1 or Y_2 via a connecting group; and

X^- represents a non-nucleophilic anion.

15. (original): A method of forming a resist pattern, which comprises: forming a film including the photosensitive composition described in claim 1; irradiating the film with an actinic ray; and developing the irradiated film.

16. (canceled).

17. (canceled).

18. (canceled).